Shenzhen Leadtek Electronics Co.,Ltd

PRODUCT SPECIFICATION TFT-LCD MODULE

Module No: LTK050HDHCT13-V0

- ☑ Preliminary Specification
- ☐ Approval Specification

Designed by	Checked by	Approved by
lan	Ridi	Steven

Final Approval by Customer

Approved by	Comment

**The specification of "TBD" should refer to the measured value of sample . If there is difference between the design specification and measured value, we naturally shall negotiate and agree to solution with customer.

Revision Record

REV NO.	REV DATE	CONTENTS	Note
V0	2023-02-16	NEW ISSUE	

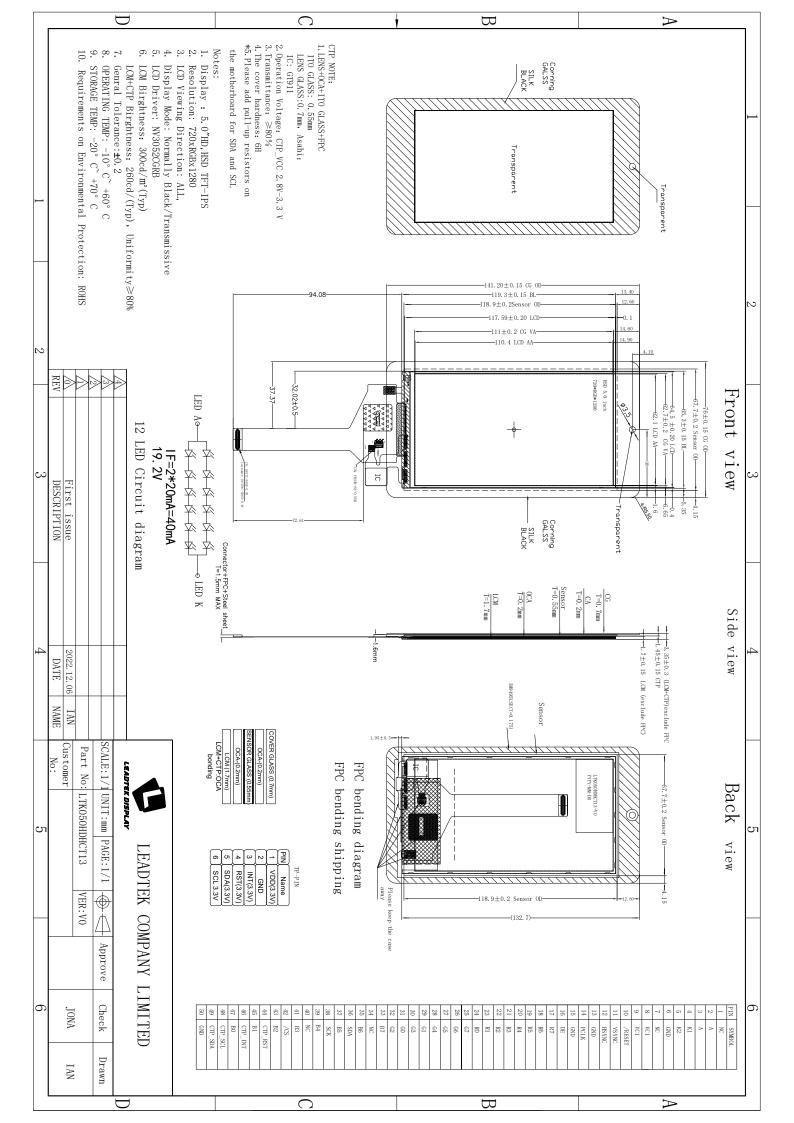
1. Numbering System

2. TFT General Information

ITEM	STANDARD VALUES	UNITS
LCD type	5.0"TFT	
Dot arrangement	720(RGB)×1280	dots
Color filter array	RGB vertical stripe	
Display mode	IPS / Transmissive / Normally Black	
Viewing Direction	80/80/80	
TFT Driver IC	NV3052CGRB	
CTP type	NC	
Surface Treatment	NC	
CTP Driver IC	GT911	
Module size	76.00(W)×141.20(H)×3.35(T)	mm
Active area	62.1(W)×110.4(H)	mm
LENS Viewing area	NC	mm
Dot pitch	0.08625(H) x 0.08625(V)	mm
Interface	3line SPI + 24bit RGB	
Operating temperature	-20 ~ +70	C
Storage temperature	-30 ~ +80	C
Back Light	12pcs White LED	
Weight	TBD	g

3. Mechanical Drawing





4 Interface Description

4. Interf	ace Descr	iption
PIN NO.	PIN NAME	DESCRIPTION
1	NC	NC
2	А	Power supply for backlight anode input terminal.
3	А	Power supply for backlight anode input terminal.
4	K	Power supply for backlight cathode input terminals.
5	K	Power supply for backlight cathode input terminals.
6	GND	Ground
7	NC	NC
8	VCI	TFT and CTP power supply input.
9	VCI	TFT and CTP power supply input.
10	/RESET	Reset signal input terminal, active at 'L'.
11	VSYNC	Vertical Sync Input
12	HSYNC	Horizontal Sync Input
13	GND	Ground
14	PCLK	Dot Data Clock
15	GND	Ground
16	DE	Data Enable Input
17	R7	
18	R6	
19	R5	
20	R4	Dod data has
21	R3	Red data bus.
22	R2	
23	R1	
24	R0	
25	G7	
26	G6	
27	G5	
28	G4	Croon data bug
29	G1	Green data bus.
30	G3	
31	G0	
32	G2	



33	В7	Blue data bus.
34	NC	NC
35	B6	Blue data bus.
36	SDA	SPI Interface Data.
37	B5	Blue data bus.
38	SCL	SPI Interface Data Clock.
39	B4	Blue data bus.
40	NC	NC
41	В3	Blue data bus.
42	/CS	Chip select signal, Active "L"
43	B2	Blue data bus.
44	CTP_RST	CTP reset line.
45	B1	Blue data bus.
46	CTP_INT	CTP interrupt line.
47	В0	Blue data bus.
48	CTP_SCL	CTP I2C clock line.
49	CTP_SDA	CTP I2C data line.
50	GND	Ground

5. Absolute Maximum Ratings

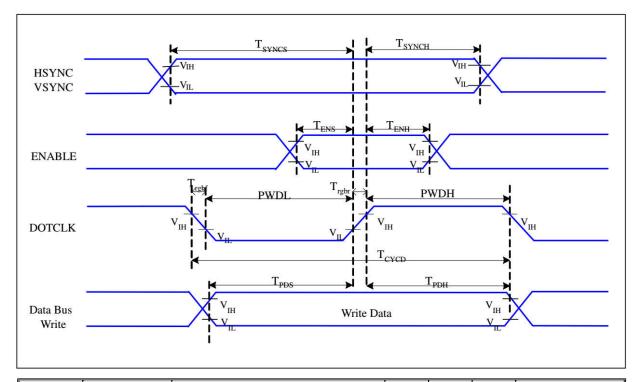
ltem	Symbol	Min.	Max.	Unit
Analog Supply Voltage	VCI	-0.3	3.6	V
Input Voltage	Vin	-0.3	VCI+0.5	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Тѕт	-30	80	°C
Storage Humidity	HD	20	90	%RH

6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Analog Supply Voltage	VCI	2.5	2.8	3.3	٧	-
Input High Voltage	V _{IH}	0.7VCI	-	VCI	٧	Digital input pins
Input Low Voltage	V _{IL}	GND	-	0.3VCI	٧	Digital input pins
Output High Voltage	V _{OH}	0.8VCI	-	VCI	٧	Digital output pins
Output Low Voltage	V_{OL}	GND	-	0.2VCI	٧	Digital output pins
I/O Leak Current	ILI	-1.0	-	1.0	uA	-

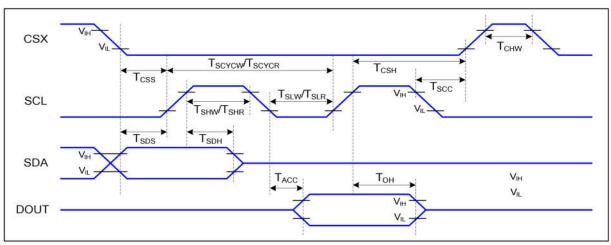
7. Timing Characteristics

7.1 RGB Interface Characteristics



Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC, VSYNC	T _{SYNCS}	VSYNC, HSYNC Setup Time	5	-	ns	
ENABLE	T _{ENS}	Enable Setup Time	5	-	ns	
ENABLE	T _{ENH}	Enable Hold Time	5	-	ns	
	PWDH	DOTCLK High-level Pulse Width	15	-	ns	
DOTCLK	PWDL	DOTCLK Low-level Pulse Width	15	-	ns	
DOTCLK	T _{CYCD}	DOTCLK Cycle Time	33	-	ns	
	Trghr, Trghf	DOTCLK Rise/Fall time		15	ns	
DB	T _{PDS} PD Data Setup Time 5		-	ns		
DB	T_PDH	PD Data Hold Time	5	-	ns	

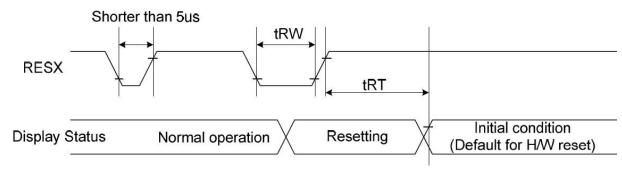
7.2 Serial Interface Characteristics (3-line serial)





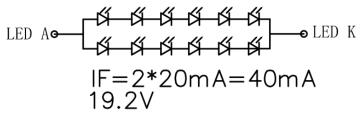
Signal	Symbol	Parameter	Min	Max	Unit	Description
	T _{CSS}	Chip select setup time (write)	15		ns	
	T _{CSH}	Chip select hold time (write)	15		ns	
csx	T _{CSS}	Chip select setup time (read)	60		ns	
	T _{SCC}	Chip select hold time (read)	60		ns	
	T _{CHW}	Chip select "H" pulse width	40		ns	
	T _{SCYCW}	Serial clock cycle (Write)	66		ns	
	T _{SHW}	SCL "H" pulse width (Write)	15		ns	
SCL	T _{SLW}	SCL "L" pulse width (Write) 15			ns	
SOL	T _{SCYCR}	Serial clock cycle (Read)	150 ns		ns	
	T _{SHR}	SCL "H" pulse width (Read)	60	60 ns		
	T _{SLR}	SCL "L" pulse width (Read)	60		ns	
SDA	T _{SDS}	Data setup time	10		ns	
(DIN)	T _{SDH}	Data hold time	10		ns	

7.3 Reset Timing Characteristics



Signal	Symbol	Parameter	Parameter Min		Unit
	tRW	Reset pulse duration	10		uS
RESX	4DT	D		5 (note 1,5)	mS
	tRT	Reset cancel		120 (note 1,6,7)	mS

8. Backlight Charasterics



Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	-	19.2	-	V	If=40mA
Supply Current	If	-	40	-	mA	-
Luminous Intensity for LCM	-	-	260	-	Cd/m ²	If=40mA
Uniformity for LCM	-	80	-	-	%	If=40mA
Life Time	-	20000	-	-	Hr	If=40mA
Backlight Color				White		

9. Optical Characteristics

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Transmittance (with Polarizer)		T (%)			(4.2)	-	0/.	Measuring with normal polarizer , Reference Only Base on Vop=5.1V
Transmittance (without Polarizer)		T (%)		_	(14.7)	_	%	·
Contrast Ratio		CR		640	800	l	_	(1)(2)
Response Time		$T_{R+}T_{F}$		_	25	35	msec	(1)(3)
Color Gamut (%)			Θ=0	55	60	1	%	C-light
	Hor.	ΘL	CR>10	70	80	-		(1)(4)
) (i a coning as A as as la		Θ_{R}		70	80	1		(1)(4) Measuring with
Viewing Angle	Ver.	Θυ		70	80	ı		normal polarizer ,
		Θ _D		70	80	_		Reference Only
Optima View D	irection		Free				(5)	

Note:

- 1. Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface (see FIG.2).
- 2. Contrast measurements shall be made at viewing angle of Θ = 0 and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state. (See FIG. 2) Luminance Contrast Ratio (CR) is defined mathematically. CR = White Luminance (ON) / Black Luminance (OFF)
- 3. Transmittance is the value with DBEF Polarizer.
- 4. The color chromaticity coordinates specified in Table1 shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the C/F. Measurement condition is C light source & Halogen Lamp
- 5. The electro-optical response time measurements shall be made as FIG.3 by switching the "data" input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is Tr , and 90% to 10% is Tf.

Figure 1. The definition of Vth & Vsat

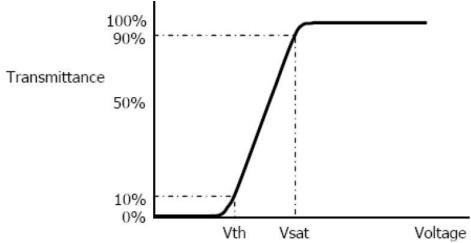


Figure 2. Measurement Set Up

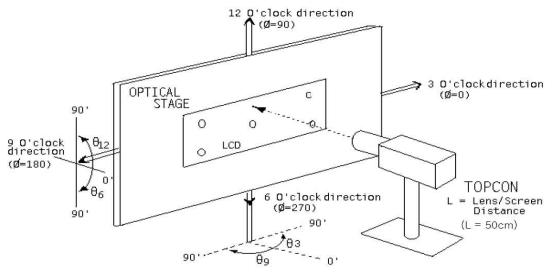
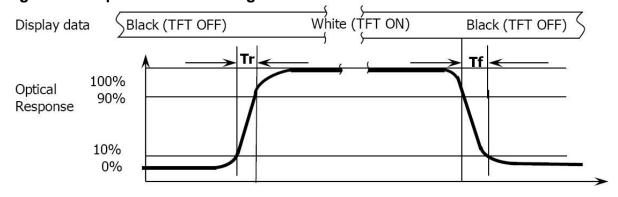


Figure 3. Response Time Testing



10. Reliability Test Conditions And Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST
1	High Temperature Storage	80℃±2℃×96Hours	
2	Low Temperature Storage	-30℃±2℃×96Hours	
3	High Temperature Operating	70℃±2℃×96Hours	Inspection after 2~4hours
4	Low Temperature Operating -20 ℃±2 ℃ ×96Hours		storage at room temperature,the samples should be free from
5	Temperature Cycle(Storage)		
6	Damp Proof Test (Storage)	50℃±5℃×90%RH×96Hours	5,Glass crack. 6,Current IDD is twice higher than initial value.
7	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5M X,Y,Z direction for total 3hours (Packing Condition)	7,The surface shall be free from damage. 8,The electric charateristic requirements shall be
8	Drooping Test	Drop to the ground from 1M height one time every side of carton. (Packing Condition)	satisfied.
9	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Air Mode,10times	

REMARK:

- 1,The Test samples should be applied to only one test item.
- 2, Sample side for each test item is 5~10pcs.
- 3,For Damp Proof Test,Pure water(Resistance $> 10M\Omega$)should be used.
- 4,In case of malfunction defect caused by ESD damage,if it would be recovered to normal state after resetting,it would be judge as a good part.
- 5,EL evaluation should be excepted from reliability test with humidity and temperature:Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

11. Inspection Standard

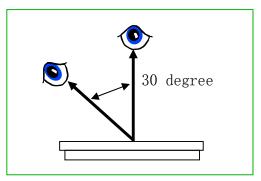
This standard apply to C-STN/TFT module

1. Spot check plan:

According to spot check level II, MIL-STD-105D Level II, the rank of accept or reject is below:

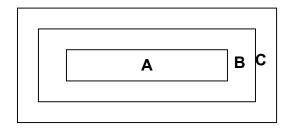
A 级: major non-conformance: AQL 0.65 minor non-conformance: AQL 1.

2. Inspection condition:



Under daylight lamp 20 $\sim\!40W_{\odot}$ product distance inspector'eye 30cm,incline degree 30° $_{\circ}$

3. LCD area define:



Area A: display area

Area B: VA area

Area C: out of VA area, not in sight after assemby

Remark :non-conformance at area C,but is OK that isn't influence raliability of product & assembly by customer.

4. Inspection standard

4.1 Major non-conformance

NO.	Item	Inspection standard	Rate
4.1.1	Function non-confor mance	 No display, display abnormaly Miss line, short B/L no function or function abnormaly TP no function 	major
4.1.2	miss	No matter miss what component	
4.1.3	Out of size	Module dimension out of spec	

4.2 Appearance non-conformance

NO.	Item	Inspection standard R							Rate	
		dot non-conformance define Φ $\Phi = \frac{(x+y)}{2}$								
		A grade								
		area size (mm)		Most approve q'ty						
	Black or white			Α	В		С			
4.2.1	spot	Ф≤0.10			ignore				Minor	
	(power on)	0.10<Φ≤	0.15		3					
		0.15<Φ≤0.20			2		ignor	e		
		0.20<Φ≤0.25		1						
		0.25<Ф		0						
		Most approv	e 4 da	mages,	dot to	dot ≥	10mm			
	Black or white line (power on)	A grade								
		Size	Most ap			st approve	approve q'ty			
		L(length)	W(w	ridth)	Α		В	С		
		ignore	W≤0.03		ignore			Minor		
4.2.2		L≤5.0	0.03< W≤0.05		2		ignore			
		L≤3.0	0.05< W≤0.07		1					
			0.07 <w< td=""><td colspan="2">Treat with dot non-conformance</td><td></td></w<>		Treat with dot non-conformance					
		Most approve 3 damages, line to line ≥10mm								
4.2.3	Polarizer position	polarizer attach meet drawing, disallow out of LCD. polarizer must cover display area (special require unless)						Minor		



		(i) crash at side (remark: S=ITO length)		
4.2.4	LCD non-conf ormance	(ii) crash at side (remark: S=ITO length) X Y Z 	Minor	
4.2.	Contrast voltage arp	VOP/VIcd voltage of confirmed sample±0.15V	Minor	
4.2.6	color	Color & luminance of module scope reference spec	Minor	
4.2.7	Cross talk	Reference confirmed limit sample	Minor	

12. Handling Precautions

12.1 Mounting method

The LCD panel of LTK LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent [recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (Cl) , Salfur (S)

If goods were sent without being sili8con coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Salfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

12.4 packing

- Module employ LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
 - Usage under the maximum operating temperature, 50%Rh or less is required.



12.6 storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it.
 And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution For Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to LTK LCD, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method

TBD